

Overview

The KEMET T498 Series is a high temperature product that offers optimum performance characteristics in applications with operating temperatures up to 150°C. Advanced materials and testing allow this series to perform with a reliability level of 0.5%/1000 hours at rated voltage and temperature. The T498 Series is available in five standard EIA case sizes with RoHS compliant terminations as standard.

Benefits

- Meets or exceeds EIA standard 535BAAC
- Taped and reeled per EIA 481-D
- Symmetrical, compliant terminations
- Optional gold-plated terminations
- Laser-marked case
- 100% surge current testing
- Complies with AEC-Q200
- Capacitance values of 0.47µF to 220µF
- Tolerances of ±10% and ±20%
- Voltage rating of 6-50 VDC
- 100% steady-state accelerated aging
- Temperature/voltage derating is 2/3 at 150°C
- RoHS compliance and lead-free terminations standard
- Operating temperature range of -55°C to +150°C

Applications

Typical applications include decoupling and filtering in industrial and automotive end applications such as DC/DC converters, portable electronics, telecommunications, and control units operating at temperatures up to 150°C.



Environmental Compliance

RoHS Compliant (6/6)* according to Directive 2002/95/EC

**When ordered with 100% Sn Solder*



RoHS Compliant

SPICE

For a detailed analysis of specific part numbers, please visit kemet.com for a free download of KEMET's SPICE software. The KEMET SPICE program is freeware intended to aid design engineers in analyzing the performance of these capacitors over frequency, temperature, ripple, and DC bias conditions.

Ordering Information

T	498	X	227	M	010	A	T	E500	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Voltage	Failure Rate/Design	Lead Material	ESR Code	Packaging (C-Spec)
T = Tantalum	High Temperature 150°C	A = 3216-18 B = 3528-21 C = 6032-28 D = 7343-31 X = 7343-43	First two digits represent significant figures. Third digit specifies number of zeros.	K = ±10% M = ±20%	006 = 6.3V 010 = 10V 016 = 16V 020 = 20V 025 = 25V 035 = 35V 050 = 50V	A = N/A Z = N/A	T = 100% Matte Tin (Sn) Plated G = Gold Plated	E = ESR Last three digits specify ESR in mΩ. (500 = 500mΩ)	Blank = 7" Reel 7280 = 13" Reel

Performance Characteristics

Item	Performance Characteristics
Operating Temperature	-55°C to 150°C
Rated Capacitance Range	0.33 μF–220 μF @ 120 Hz/25°C
Capacitance Tolerance	K Tolerance (10%), M Tolerance (20%)
Rated Voltage Range	6V–50V
DF (120Hz)	Refer to Part Number Electrical Specification Table
ESR (100kHz)	Refer to Part Number Electrical Specification Table
Leakage Current	≤ 0.01CV (μA) at rated voltage after 5 minutes

Qualification

Test	Condition	Characteristics					
Endurance	150°C @ 2/3 Rated Voltage, 2,000 Hours	ΔC/C	Within ±10% of initial value				
		DF	Within initial limits				
		DCL	Within 1.25 x initial limit				
		ESR	Within initial limits				
Storage Life	150°C @ 0 Volts, 2,000 Hours	ΔC/C	Within ±10% of initial value				
		DF	Within initial limits				
		DCL	Within 1.25 x initial limit				
		ESR	Within initial limits				
Thermal Shock	MIL-STD-202, Method 107, Condition B, mounted, -55°C to 150°C, 1,000 cycles	ΔC/C	Within ±5% of initial value				
		DF	Within initial limits				
		DCL	Within 1.25 x initial limit				
		ESR	Within initial limits				
Temperature Stability	Extreme temperature exposure at a succession of continuous steps at +25°C, -55°C, +25°C, +85°C, +150°C, +25°C	+25°C	-55°C	+85°C	+150°C		
		ΔC/C	IL*	±10%	±10%	±20%	
		DF	IL	IL	1.5 x IL	1.5 x IL	
		DCL	IL	n/a	10 x IL	12 x IL	
		Surge Voltage	25°C and 85°C, 1.32 x Rated Voltage 1,000 cycles (150°C, 1.2 x Rated Voltage)	ΔC/C	Within ±5% of initial value		
				DF	Within initial limits		
DCL	Within initial limits						
ESR	Within initial limits						
Mechanical Shock/Vibration	MIL-Std-202, Meth. 213, Cond. I, 100G Peak. MIL-Std-202, Meth. 204, Cond. D, 10Hz to 2000Hz, 20G Peak	ΔC/C	Within ±10% of initial value				
		DF	Within initial limits				
		DCL	Within initial limits				

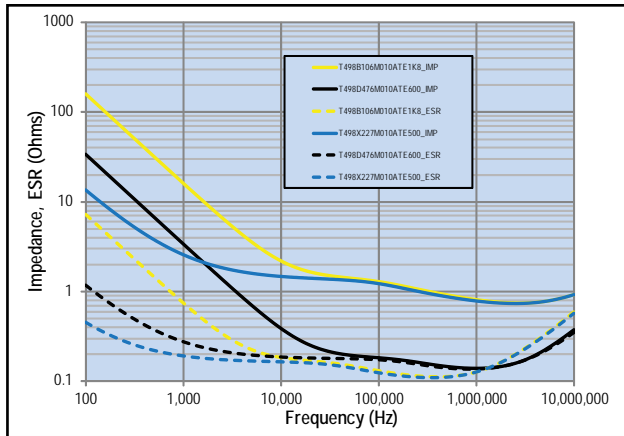
*IL = Initial Limit

Certification

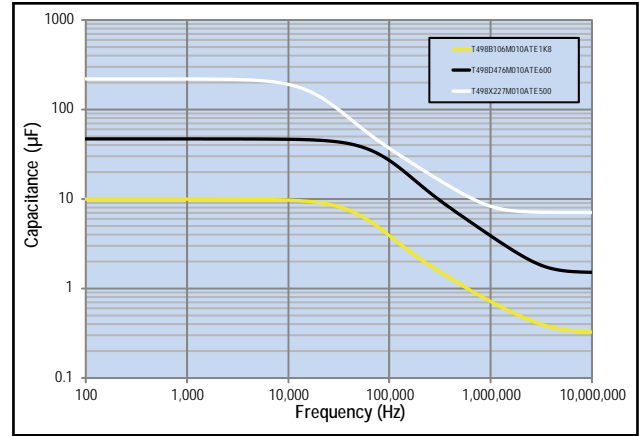
KEMET's Internal Qualification Plan for this Tantalum series of capacitors follows AEC-Q200 guidelines. Standard catalog part types ordered without a specific automotive designator, i.e., suffix AUTO or four digit customer specific designator (C SPEC), are not considered KEMET Automotive Grade Tantalum capacitors.

Electrical Characteristics

ESR vs. Frequency

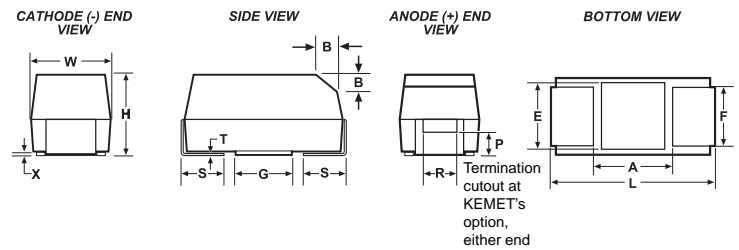


Capacitance vs. Frequency



Dimensions – Millimeters (Inches)

Metric will govern



Case Size		Component												
KEMET	EIA	L*	W*	H*	F* ±0.1 ±(.004)	S* ±0.3 ±(.012)	B* ±0.15 (Ref) ±.006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
A	3216-18	3.2 ± 0.2 (.126 ± .008)	1.6 ± 0.2 (.063 ± .008)	1.6 ± 0.2 (.063 ± .008)	1.2 (.047)	0.8 (.031)	0.4 (.016)	0.10 ± 0.10 (.004 ± .004)	0.4 (.016)	0.4 (.016)	0.13 (.005)	1.4 (.055)	1.1 (.043)	1.3 (.051)
B	3528-21	3.5 ± 0.2 (.138 ± .008)	2.8 ± 0.2 (.110 ± .008)	1.9 ± 0.2 (.075 ± .008)	2.2 (.087)	0.8 (.031)	0.4 (.016)	0.10 ± 0.10 (.004 ± .004)	0.5 (.020)	1.0 (.039)	0.13 (.005)	2.1 (.083)	1.8 (.071)	2.2 (.087)
C	6032-28	6.0 ± 0.3 (.236 ± .03)	3.2 ± 0.3 (.126 ± .012)	2.5 ± 0.3 (.098 ± .012)	2.2 (.087)	1.3 (.051)	0.5 (.020)	0.10 ± 0.10 (.004 ± .004)	0.9 (.035)	1.0 (.039)	0.13 (.005)	3.1 (.122)	2.8 (.110)	2.4 (.094)
D	7343-31	7.3 ± 0.3 (.287 ± .012)	4.3 ± 0.3 (.169 ± .012)	2.8 ± 0.3 (.110 ± .012)	2.4 (.094)	1.3 (.051)	0.5 (.020)	0.10 ± 0.10 (.004 ± .004)	0.9 (.035)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)
X	7343-43	7.3 ± 0.3 (.287 ± .012)	4.3 ± 0.3 (.169 ± .012)	4.0 ± 0.3 (.157 ± .012)	2.4 (.094)	1.3 (.051)	0.5 (.020)	0.10 ± 0.10 (.004 ± .004)	1.7 (.067)	1.0 (.039)	0.13 (.005)	3.8 (.150)	3.5 (.138)	3.5 (.138)

Notes: (Ref) – Dimensions provided for reference only. No dimensions provided for B, P or R because low profile cases do not have a bevel or a notch.

* MIL-C-55365/8 specified dimensions

Table 1 – Ratings & Part Number Reference

Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current			Moisture Sensitivity
							(mArms) 100 Khz 25°C	(mArms) 100kHz +85°C	(mArms) 100kHz +125°C	
VDC	µF	KEMET/EIA	(See below for part options)	µAmps +20°C max/5min	% @ +20°C 120 Hz max	Ω @ 20°C 100 kHz max	(mArms) 100 Khz 25°C	(mArms) 100kHz +85°C	(mArms) 100kHz +125°C	Reflow Temp≤260°C
6.3	10	B/3528-21	T498B106(1)006A(2)E2K1	0.6	6.0	2100	201	181	80	1
6.3	15	B/3528-21	T498B156(1)006A(2)E1K8	0.9	6.0	1800	217	195	87	1
6.3	22	C/6032-28	T498C226(1)006A(2)E1K3	1.4	6.0	1300	291	262	116	1
6.3	33	B/3528-21	T498B336(1)006A(2)E1K7	2.1	6.0	1700	224	202	90	1
6.3	47	C/6032-28	T498C476(1)006A(2)E800	3.0	6.0	800	371	334	148	1
6.3	100	D/7343-31	T498D107(1)006A(2)E600	6.3	8.0	600	500	450	200	1
10	2.2	A/3216-18	T498A225(1)010A(2)E4K6	0.5	6.0	4600	128	115	51	1
10	3.3	A/3216-18	T498A335(1)010A(2)E3K6	0.5	6.0	3600	144	130	58	1
10	4.7	A/3216-18	T498A475(1)010A(2)E2K9	0.5	6.0	2900	161	145	64	1
10	4.7	B/3528-21	T498B475(1)010A(2)E2K7	0.5	6.0	2700	177	159	71	1
10	10	B/3528-21	T498B106(1)010A(2)E1K8	1.0	6.0	1800	217	195	87	1
10	15	B/3528-21	T498B156(1)010A(2)E1K5	1.5	6.0	1500	238	214	95	1
10	15	C/6032-28	T498C156(1)010A(2)E1K8	1.5	6.0	1800	247	222	99	1
10	22	B/3528-21	T498B226(1)010A(2)E1K5	2.2	6.0	1500	238	214	95	1
10	22	C/6032-28	T498C226(1)010A(2)E1K1	2.2	6.0	1100	316	284	126	1
10	47	D/7343-31	T498D476(1)010A(2)E600	4.7	6.0	600	500	450	200	1
10	100	D/7343-31	T498D107(1)010A(2)E600	10.0	8.0	600	500	450	200	1
10	220	X/7343-43	T498X227(1)010A(2)E500	22.0	8.0	500	574	517	230	1
16	1	A/3216-18	T498A105(1)016A(2)E6K5	0.5	4.0	6500	107	96	43	1
16	3.3	A/3216-18	T498A335(1)016A(2)E3K4	0.5	6.0	3400	149	134	60	1
16	4.7	B/3528-21	T498B475(1)016A(2)E2K1	0.8	6.0	2100	201	181	80	1
16	6.8	A/3216-18	T498A685(1)016A(2)E2K6	1.1	6.0	2600	170	153	68	1
16	6.8	B/3528-21	T498B685(1)016A(2)E1K8	1.1	6.0	1800	217	195	87	1
16	10	B/3528-21	T498B106(1)016A(2)E2K8	1.6	6.0	2800	174	157	70	1
16	10	C/6032-28	T498C106(1)016A(2)E1K4	1.6	6.0	1400	280	252	112	1
16	15	C/6032-28	T498C156(1)016A(2)E1K1	2.4	6.0	1100	316	284	126	1
16	22	C/6032-28	T498C226(1)016A(2)E1K0	3.5	6.0	1000	332	299	133	1
16	33	D/7343-31	T498D336(1)016A(2)E600	5.3	6.0	600	500	450	200	1
16	47	D/7343-31	T498D476(1)016A(2)E600	7.5	6.0	600	500	450	200	1
16	68	D/7343-31	T498D686(1)016A(2)E600	10.9	6.0	600	500	450	200	1
16	100	X/7343-43	T498X107(1)016A(2)E100	16.0	8.0	100	1285	1157	514	1
20	1	A/3216-18	T498A105(1)020A(2)E5K9	0.5	0.5	5900	113	102	45	1
20	10	C/6032-28	T498C106(1)020A(2)E1K1	2.0	2.0	1100	316	284	126	1
25	0.47	A/3216-18	T498A474(1)025A(2)E8K5	0.5	4.0	8500	94	85	38	1
25	2.2	B/3528-21	T498B225(1)025A(2)E3K0	0.6	6.0	3000	168	151	67	1
25	10	C/6032-28	T498C106(1)025A(2)E1K1	2.5	6.0	1100	316	284	126	1
25	10	D/7343-31	T498D106(1)025A(2)E1K0	2.5	6.0	1000	387	348	155	1
25	15	D/7343-31	T498D156(1)025A(2)E700	3.8	6.0	700	463	417	185	1
25	22	D/7343-31	T498D226(1)025A(2)E600	5.5	6.0	600	500	450	200	1
25	33	D/7343-31	T498D336(1)025A(2)E600	8.3	6.0	600	500	450	200	1
35	0.33	A/3216-18	T498A334(1)035A(2)E11K	0.5	4.0	11000	83	75	33	1
35	1	A/3216-18	T498A105(1)035A(2)E10K	0.5	4.0	10000	87	78	35	1
35	1.5	C/6032-28	T498C155(1)035A(2)E3K3	0.5	6.0	3300	183	165	73	1
35	3.3	C/6032-28	T498C335(1)035A(2)E1K7	1.2	6.0	1700	254	229	102	1
35	6.8	D/7343-31	T498D685(1)035A(2)E900	2.4	6.0	900	408	367	163	1
VDC	µF	KEMET/EIA	(See below for part options)	µAmps +20°C max/5min	% @ +20°C 120 Hz max	Ω @ 20°C 100 kHz max	(mArms) 100 Khz 25°C	(mArms) 100kHz +85°C	(mArms) 100kHz +125°C	Reflow Temp≤260°C
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current			Moisture Sensitivity

(1) To complete KEMET part number, insert M for ± 20% or K for ± 10%. Designates Capacitance tolerance.

(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated. Designates Termination Finish.

Refer to Ordering Information for additional detail.

Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

Table 1 – Ratings & Part Number Reference cont'd

Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current			Moisture Sensitivity
							(mArms) 100 Khz 25°C	(mArms) 100kHz +85°C	(mArms) 100kHz +125°C	
VDC	µF	KEMET/EIA	(See below for part options)	µAmps +20°C max/5min	% @ +20°C 120 Hz max	Ω @ 20°C 100 kHz max	(mArms) 100 Khz 25°C	(mArms) 100kHz +85°C	(mArms) 100kHz +125°C	Reflow Temp≤260°C
35	10	D/7343-31	T498D106(1)035A(20)E700	3.5	6.0	700	463	417	185	1
35	22	X/7343-43	T498X226(1)035A(2)E500	7.7	6.0	500	574	517	230	1
35	33	X/7343-43	T498X336(1)035A(2)E500	11.6	6.0	500	574	517	230	1
50	3.3	D/7343-31	T498D335(1)050A(2)E1K1	1.7	6.0	1100	369	332	148	1
50	10	D/7343-31	T498D106(1)050A(2)E1K0	5.0	6.0	1000	387	348	155	1
VDC	µF	KEMET/EIA	(See below for part options)	µAmps +20°C max/5min	% @ +20°C 120 Hz max	Ω @ 20°C 100 kHz max	(mArms) 100 Khz 25°C	(mArms) 100kHz +85°C	(mArms) 100kHz +125°C	Reflow Temp≤260°C
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Maximum Allowable Ripple Current			Moisture Sensitivity

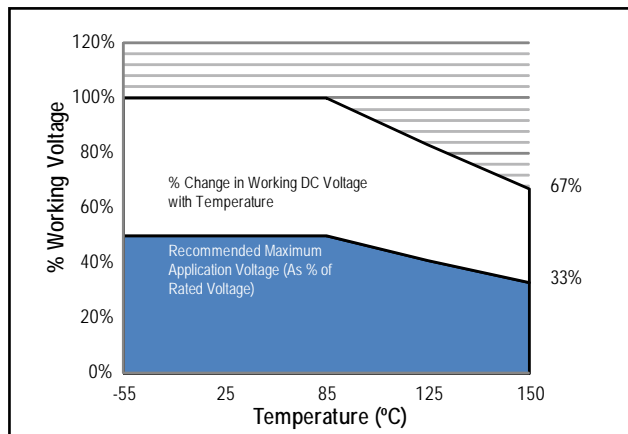
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Recommended Voltage Derating Guidelines



Ripple Current/Ripple Voltage

Case Code		Maximum Power Dissipation (Pmax) mWatts @ 25°C w/+20°C Rise
KEMET	EIA	
A	3216-18	75
B	3528-21	85
C	6032-28	110
D	7343-31	150
X	7343-43	165
E	7260-38	200
R	2012-12	25
S	3216-12	60
T	3528-12	70
U	6032-15	90
V	7343-20	125
T510X	7343-43	270
T510E	7260-38	285

Temperature Compensation Multipliers for Maximum Power Dissipation				
≤25°C	85°C	125°C	150° C*	175° C**
1.00	0.90	0.40	0.30	0.20

T = Environmental Temperature

*T498 Only

**T499 Only

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

$$I(max) = \sqrt{P_{max}/R}$$

$$E(max) = \sqrt{P_{max} \cdot R}$$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

*P*_{max} = maximum power dissipation(watts)

R = ESR at specified frequency (ohms)

Reverse Voltage

Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the table. The capacitors should not be operated continuously in reverse mode, even within these limits.

Temperature	Permissible Transient Reverse Voltage
25°C	15% of Rated Voltage
85°C	5% of Rated Voltage
125°C	1% of Rated Voltage

Table 2 – Land Dimensions/Courtyard

KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)						
		Case	EIA	X	Y	C	V1	V2	X	Y	C	V1	V2	X	Y	C	V1	V2
		A	3216-18	1.35	2.15	1.45	6.10	2.80	1.25	1.75	1.35	5.00	2.30	1.15	1.35	1.25	4.10	2.00
		B	3528-21	2.35	2.15	1.45	6.10	4.00	2.25	1.75	1.35	5.00	3.50	2.15	1.35	1.25	4.10	3.20
		C	6032-28	2.35	2.65	2.60	8.90	4.40	2.25	2.25	2.50	7.80	3.90	2.15	1.85	2.40	6.90	3.60
		D	7343-31	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70
		X ¹	7343-43	2.55	3.75	2.70	10.20	5.50	2.45	3.35	2.60	9.10	5.00	2.35	2.95	2.50	8.20	4.70

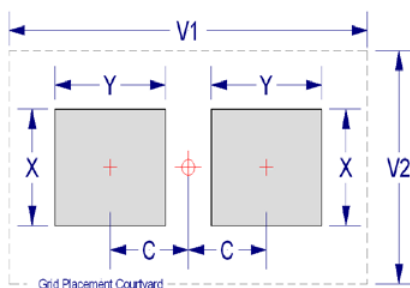
Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC-7351).

¹ Height of these chips may create problems in wave soldering.

² Land pattern geometry is too small for silkscreen outline.



Soldering Process

KEMET's families of surface mount capacitors are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

Note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurred, the iron should be removed immediately. "Wiping" the edges of a chip and heating the top surface is not recommended.

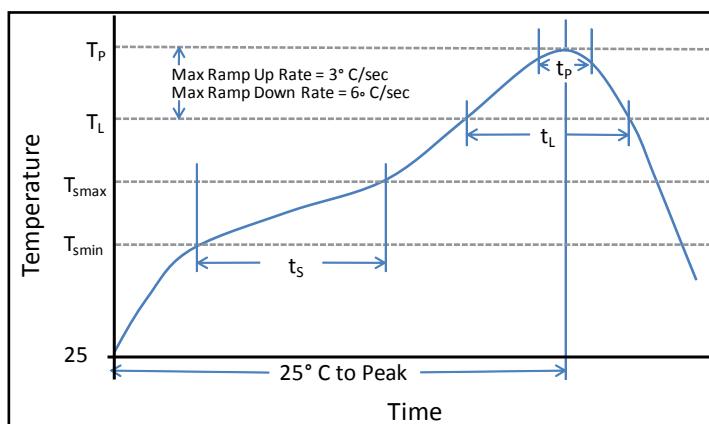
During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and is not harmful to the product. Marking permanency is not affected by this change.

Profile Feature	SnPb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Min (T_{Smin})	100°C	150°C
Temperature Max (T_{Smax})	150°C	200°C
Time (t_s) from T_{Smin} to T_{Smax}	60–120 sec	60–120 sec
Ramp-up Rate (T_L to T_p)	3°C/sec max	3°C/sec max
Liquidous Temperature (T_L)	183°C	217°C
Time Above Liquidous (t_L)	60–150 sec	60–150 sec
Peak Temperature (T_p)	220°C* 235°C**	250°C* 260°C**
Time within 5°C of Max Peak Temperature (t_p)	20 sec max	30 sec max
Ramp-down Rate (T_p to T_L)	6°C/sec max	6°C/sec max
Time 25°C to Peak Temperature	6 minutes max	8 minutes max

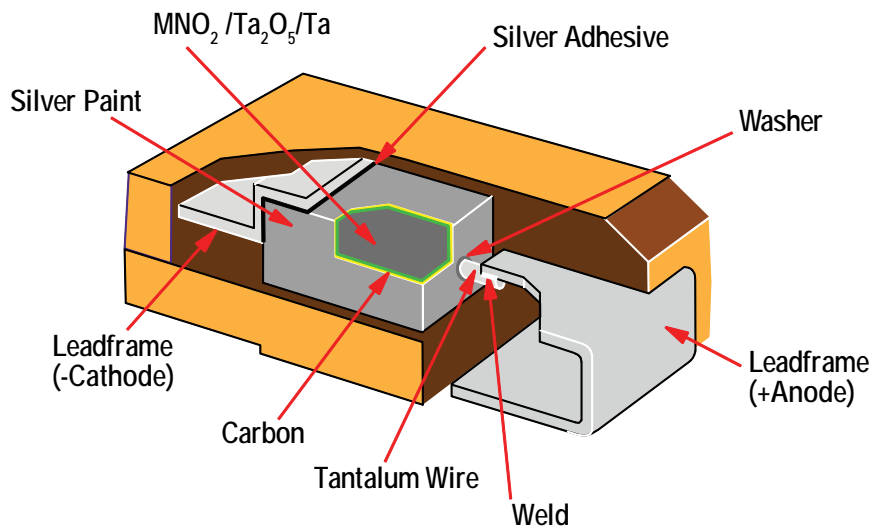
Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.

*Case Size D, E, P, Y and X

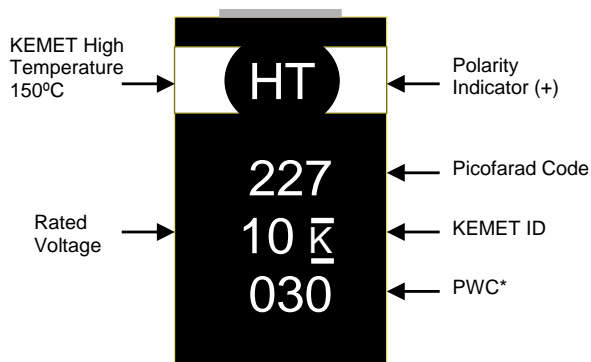
**Case Size A, B, C, H, I, K, M, R, S, T, U, V, W and Z



Construction

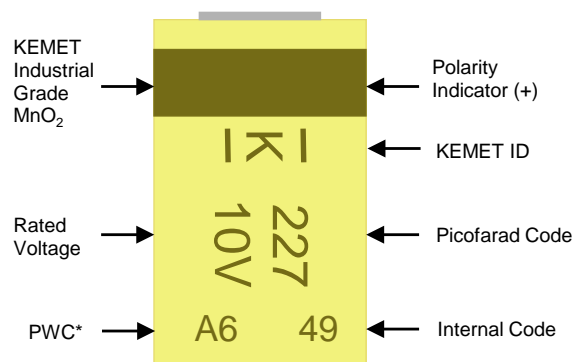


Capacitor Marking



* 030 = 30th week of 2010

C, D, X Case Sizes



PWC*		
Year	Month	
V = 2008	1 = Jan	7 = Jul
W = 2008	2 = Feb	8 = Aug
X = 2009	3 = Mar	9 = Spt
A = 2010	4 = Apr	O = Oct
B = 2011	5 = May	N = Nov
C = 2012	6 = Jun	D = Dec

Storage

Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature - reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C, and maximum storage humidity not exceed 60% relative humidity. In addition, temperature fluctuations should be minimized to avoid condensation on the parts, and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within three years of receipt.

Tape & Reel Packaging Information

KEMET's Molded Tantalum and Aluminum Chip Capacitor families are packaged in 8 mm and 12 mm plastic tape on 7" and 13" reels, in accordance with EIA Standard 481-D: Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape fed automatic pick and place systems.

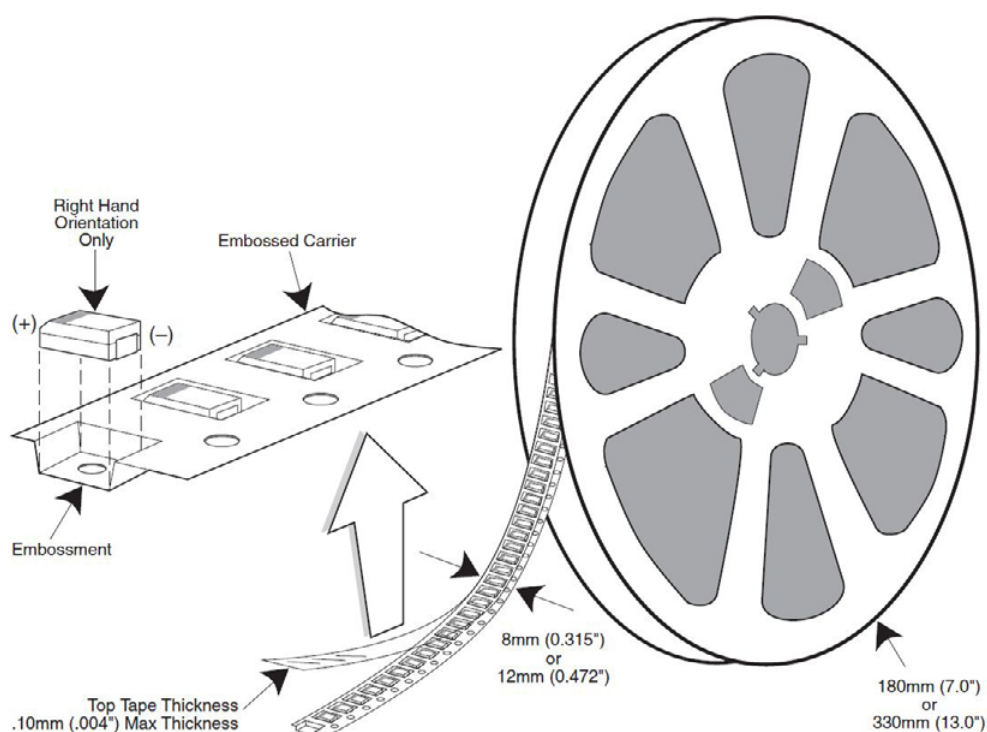


Table 3 – Packaging Quantity

Case Code		Tape Width-mm	7" Reel*	13" Reel*
KEMET	EIA			
R	2012-12	8	2,500	10,000
I	3216-10	8	3,000	12,000
S	3216-12	8	2,500	10,000
T	3528-12	8	2,500	10,000
M	3528-15	8	2,000	8,000
U	6032-15	12	1,000	5,000
L	6032-19	12	1,000	5,000
W	7343-15	12	1,000	3,000
Z	7343-17	12	1,000	3,000
V	7343-20	12	1,000	3,000
A	3216-18	8	2,000	9,000
B	3528-21	8	2,000	8,000
C	6032-28	12	500	3,000
D	7343-31	12	500	2,500
Y	7343-40	12	500	2,000
X	7343-43	12	500	2,000
E	7260-38	12	500	2,000

* No c-spec required for 7" reel packaging. C-7280 required for 13" reel packaging.

Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

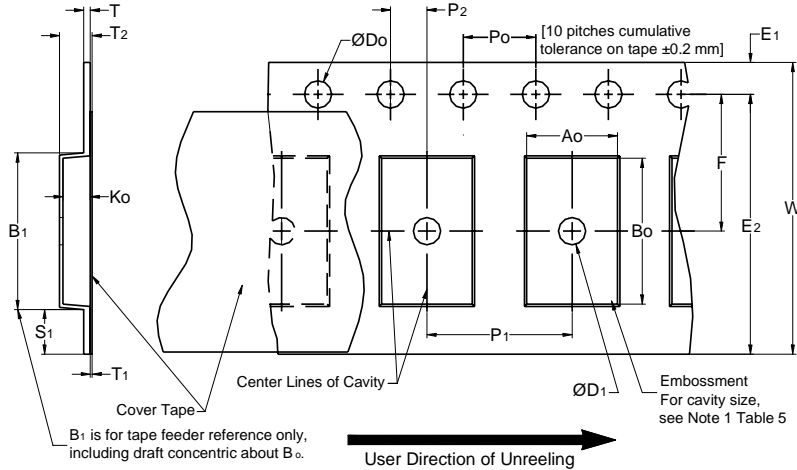


Table 4 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Min. Note 1	E ₁	P ₀	P ₂	R Ref. Note 2	S ₁ Min. Note 3	T Max.	T ₁ Max.
8 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.0 (0.039)	1.75 ± 0.10 (0.069 ± 0.004)	4.0 ± 0.10 (0.157 ± 0.004)	2.0 ± 0.05 (0.079 ± 0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12 mm		1.5 (0.059)				30 (1.181)			
16 mm									
Variable Dimensions — Millimeters (Inches)									
Tape Size	Pitch	B ₁ Max. Note 4	E ₂ Min.	F	P ₁	T ₂ Max	W Max	A ₀ , B ₀ & K ₀	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ± 0.05 (0.138 ± 0.002)	4.0 ± 0.10 (0.157 ± 0.004)	2.5 (0.098)	8.3 (0.327)	Note 5	
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ± 0.05 (0.217 ± 0.002)	8.0 ± 0.10 (0.315 ± 0.004)	4.6 (0.181)	12.3 (0.484)		
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	5.5 ± 0.05 (0.217 ± 0.002)	8.0 ± 0.10 (0.315 ± 0.004)	4.6 (0.181)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
2. The tape with or without components shall pass around R without damage (see Figure 5).
3. If S₁ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Document 481 paragraph 4.3 (b)).
4. B₁ dimension is a reference dimension for tape feeder clearance only.
5. The cavity defined by A₀, B₀ and K₀ shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12mm tapes and 10° maximum for 16mm tapes (see Figure 3).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8mm and 12mm wide tape and to 1.0mm maximum for 16mm tape (see Figure 4).
 - (e) see Addendum in EIA Document 481 for standards relating to more precise taping requirements.

Packaging Information Performance Notes

1. **Cover Tape Break Force:** 1.0 Kg minimum.
2. **Cover Tape Peel Strength:** The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 Newton to 1.0 Newton (10gf to 100gf)
12 mm & 16 mm	0.1 Newton to 1.3 Newton (10gf to 130gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300±10 mm/minute.

3. **Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA-556 and EIA-624.

Figure 2 – Maximum Component Rotation

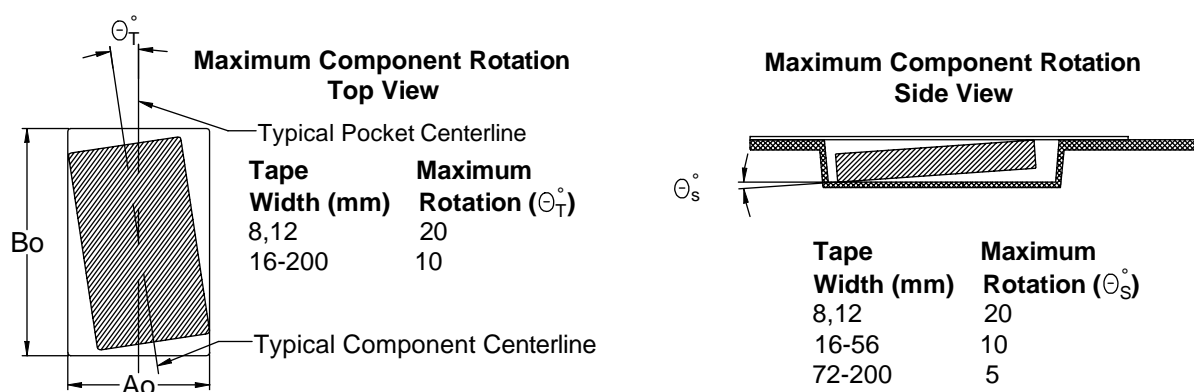


Figure 3 – Maximum Lateral Movement

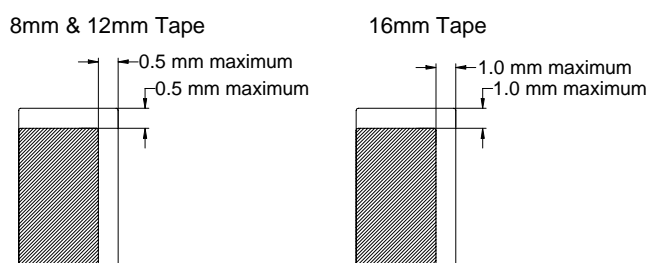


Figure 4 – Bending Radius

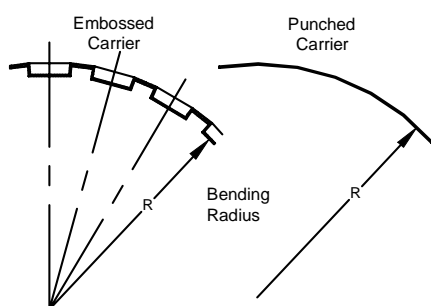
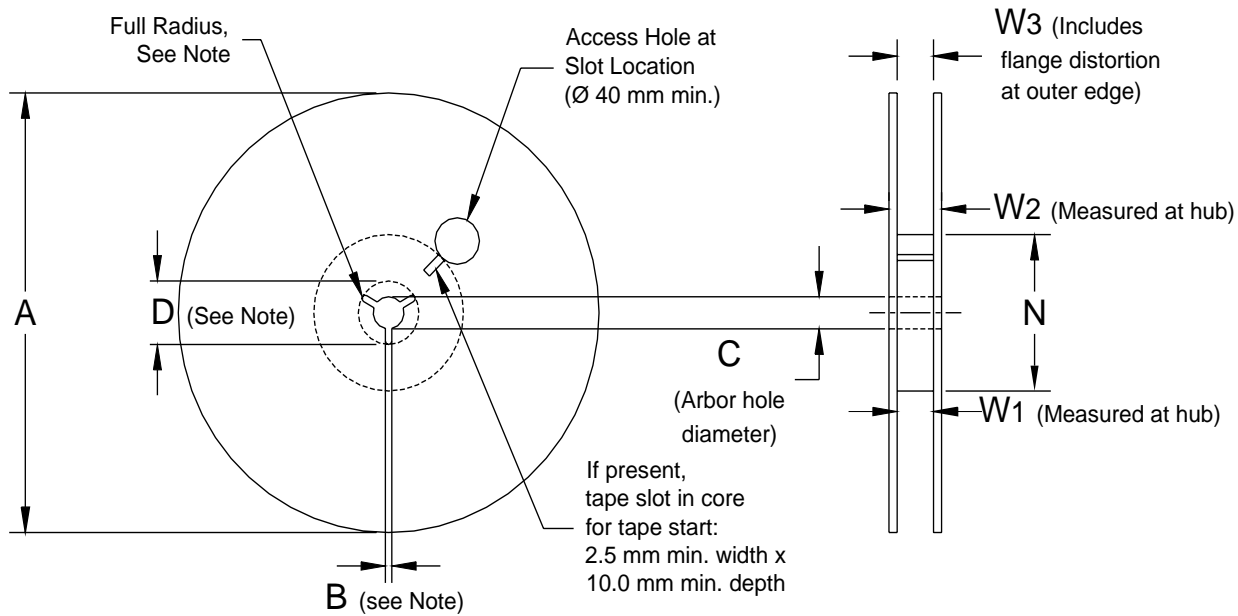


Figure 5 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 5 – Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)				
Tape Size	A	B Min	C	D Min
8 mm	178 ± 0.20 (7.008 ± 0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)
12 mm	or			
16 mm	330 ± 0.20 (13.000 ± 0.008)			
Variable Dimensions — Millimeters (Inches)				
Tape Size	N Min	W ₁	W ₂ Max	W ₃
8 mm	50 (1.969)	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape width without interference
12 mm		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)	

Figure 6 – Tape Leader & Trailer Dimensions

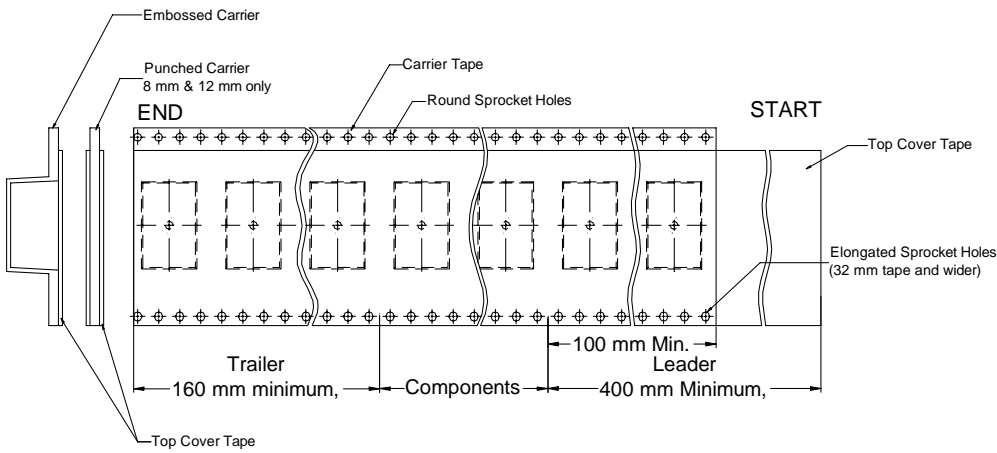
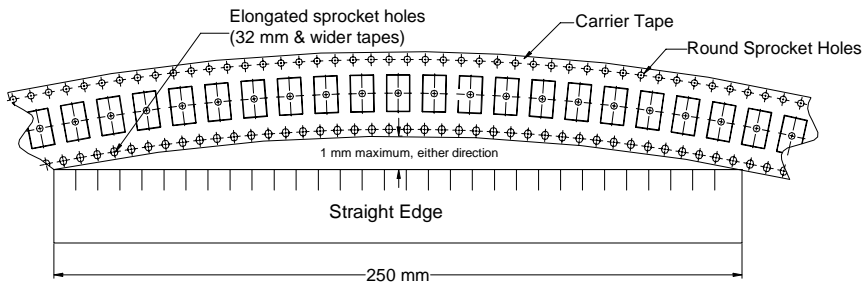


Figure 7 – Maximum Camber



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